

NCE5558G

NCE N-Channel Enhancement Mode Power MOSFET

Description

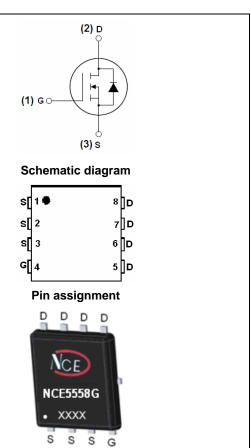
The NCE5558G uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =55V, I_{D} =58A $R_{DS(ON)} < 13mΩ @ V_{GS}$ =10V (Typ:10.5mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Synchronous rectifiers for, industrial power supplies
- LED backlighting



DFN5X6-8L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE5558G	NCE5558G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

	,				
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	55	V		
Gate-Source Voltage	V _G S	±20	V		
Drain Current-Continuous	I _D	58	Α		
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	41	А		
Pulsed Drain Current	I _{DM}	100	Α		
Maximum Power Dissipation	P _D	73	W		
Derating factor		0.23	W/°C		
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C		

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	1.7	°C/W



Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	•					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	55	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =55V,V _{GS} =0V	=55V,V _{GS} =0V -		1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	•					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	2.95	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =15A	-	12	16	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	30	-	-	S
Dynamic Characteristics (Note4)	•					
Input Capacitance	C _{lss}	\/ -20\/\/ -0\/	-	2850	-	PF
Output Capacitance	Coss	V _{DS} =30V,V _{GS} =0V,	-	258	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	26	-	PF
Switching Characteristics (Note 4)	•					
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, R_L =1.5 Ω	-	2	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =3 Ω	-	29	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg	V 20VI 20A	-	33	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =20A,	-	9	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	4	-	nC
Drain-Source Diode Characteristics	•					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	58	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =20A	-	25		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	50		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negli	gible (turr	n-on is do	minated b	y LS+LD)

Notes:

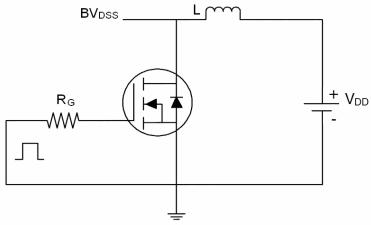
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25 $^{\circ}\text{C}$,V_{DD}=30V,V_G=10V,L=0.5mH,Rg=25 Ω



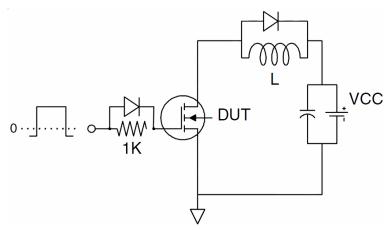
NCE5558G

Test circuit

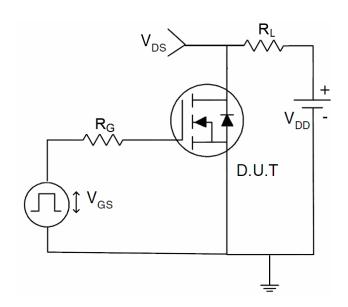
1) E_{AS} test Circuits



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

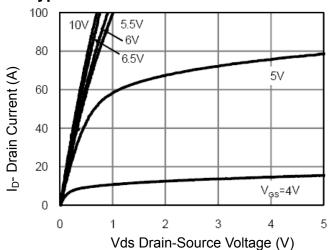


Figure 1 Output Characteristics

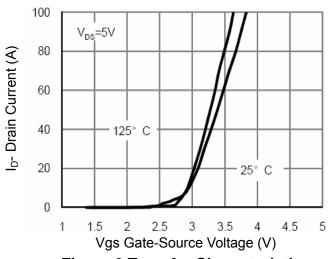


Figure 2 Transfer Characteristics

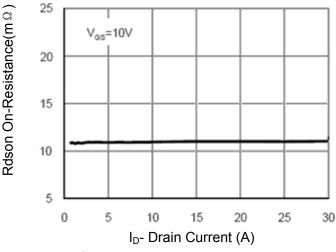


Figure 3 Rdson- Drain Current

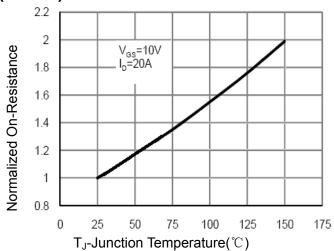


Figure 4 Rdson-JunctionTemperature

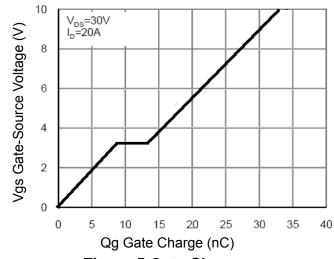


Figure 5 Gate Charge

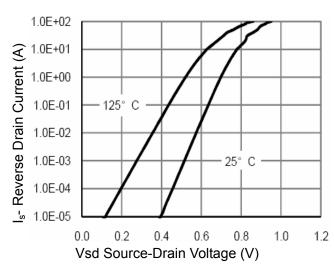
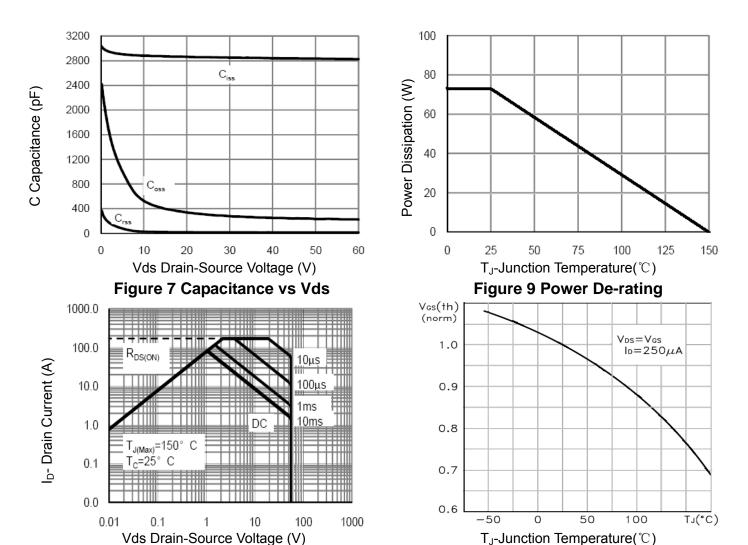


Figure 6 Source- Drain Diode Forward







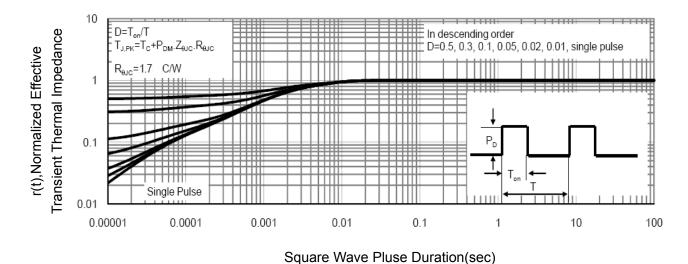
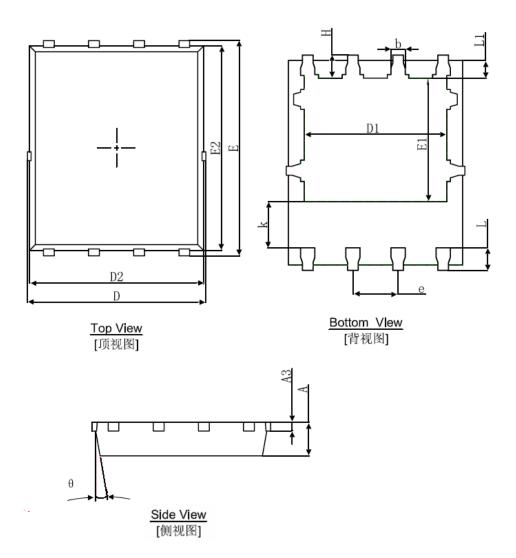


Figure 11 Normalized Maximum Transient Thermal Impedance

Figure 8 Safe Operation Area



DFN5X6-8L Package Information



C) mala a l	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254	REF.	0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270	TYP.	0.050	TYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	



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